TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (Ultra-High-Speed U-MOSIII)

TPCA8020-H

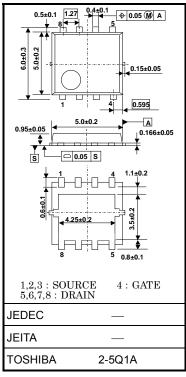
High-Efficiency DC / DC Converter Applications
Notebook PC Applications
Portable Equipment Applications
CCFL Inverter Applications

- Small footprint due to a small and thin package
- High speed switching
- Small gate charge: Qsw = 3.5 nC (typ.)
- Low drain-source ON-resistance: R_{DS} (ON) = 22 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 15 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 10 \mu A \text{ (max) (V}_{DS} = 40 \text{ V)}$
- Enhancement mode: $V_{th} = 1.1 \text{ to } 2.3 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$

Absolute Maximum Ratings (Ta = 25°C)

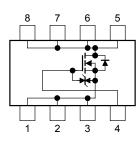
Characteristic			Symbol	Rating	Unit	
Drain-source voltage			V_{DSS}	40	V	
Drain-gate voltag	ge (R _{GS} =	= 20 kΩ)	V_{DGR}	40	V	
Gate-source volt	age		V _{GSS}	±20	V	
Drain current	DC	(Note 1)	I _D	7.5	А	
Diain current	Pulse	(Note 1)	I_{DP}	30	A	
Drain power diss	ipation	(Tc=25°C)	P _D	30	W	
Drain power diss (t = 10 s)	ipation	(Note 2a)	P_{D}	2.8	W	
Drain power diss (t = 10 s)	ipation	(Note 2b)	P _D	1.6	W	
Single-pulse avalanche energy (Note 3)			E _{AS}	26	mJ	
Avalanche current			I _{AR}	7.5	Α	
Repetitive avalanche energy Single-device value at dual operation (Note 2a, 4)			Ear	1.9	mJ	
Channel temperature			T _{ch}	150	°C	
Storage temperature range			T _{stg}	-55 to 150	°C	

Unit: mm



Weight: 0.066 g (typ.)

Circuit Configuration



Note: For Notes 1 to 4, refer to the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

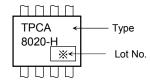
This transistor is an electrostatic-sensitive device. Handle with care.



Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case (Tc=25°C)	R _{th (ch-c)}	4.17	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	44.6	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	78.1	°C/W

Marking (Note 5)

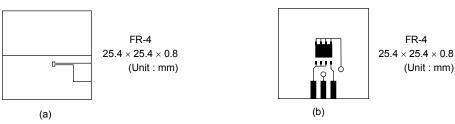


Note 1: The channel temperature should not exceed 150°C during use.

Note 2:

a) Device mounted on a glass-epoxy board (a)

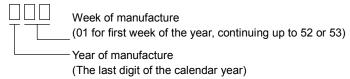
b) Device mounted on a glass-epoxy board (b)



Note 3: V_{DD} = 24 V, T_{ch} = 25°C (initial), L = 0.5 mH, R_G = 25 Ω , I_{AR} = 7.5 A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: * Weekly code: (Three digits)



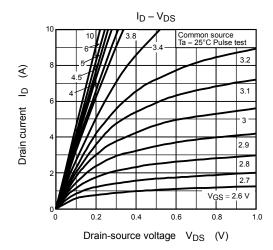
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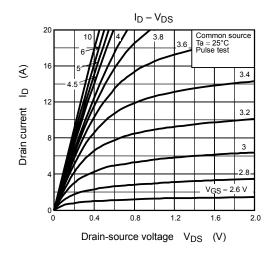
Electrical Characteristics (Ta = 25°C)

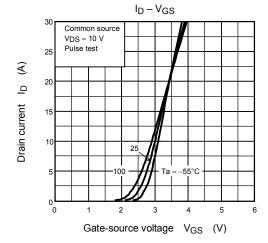
Chara	Characteristic		Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μА
Drain cutoff curr	ent	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V	_	_	10	μА
Drain-course br	D : 1 1 1 1		I _D = 10 mA, V _{GS} = 0 V	40	_	_	V
Drain-source breakdown voltage		V (BR) DSX	I_D = 10 mA, V_{GS} = -20 V	25	_	_	
Gate threshold v	Gate threshold voltage		V _{DS} = 10 V, I _D = 1 mA	1.1	_	2.3	V
Drain-course O	N resistance	R _{DS (ON)}	V _{GS} = 4.5 V, I _D = 3.8 A	_	27	35	m()
Drain-source ON-resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 3.8 A	_	22	27	mΩ
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 3.8 A	7.5	15	_	S
Input capacitano	e	C _{iss}		_	650	_	pF
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	55	_	
Output capacitance		Coss		_	240	_	
Switching time	Rise time	tr	V _{GS} ¹⁰ V	_	3	_	
	Turn-on time	t _{on}		_	9	_	no
	Fall time	t _f		_	2	_	ns
	Turn-off time	t _{off}	Duty \leq 1%, t _W = 10 μs	_	18	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq 32 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 7.5 \text{ A}$	_	11		
			$V_{DD} \simeq 32 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 7.5 \text{ A}$	_	6.2	_	
Gate-source charge		Q _{gs1}	$V_{DD} \simeq 32 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 7.5 \text{ A}$	_	2.1		nC
Gate-drain ("Miller") charge		Q _{gd}		_	2.7	_	
Gate switching charge		Q _{sw}		_	3.5		

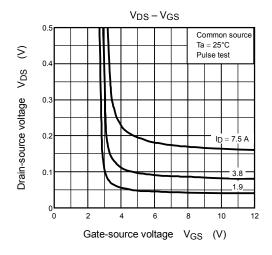
Source-Drain Ratings and Characteristics (Ta = 25°C)

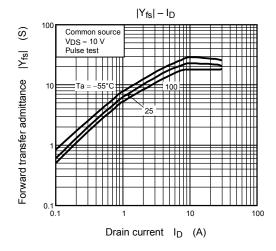
Charact	eristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	_	_	_	30	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 7.5 A, V _{GS} = 0 V	_	_	− −1.2	

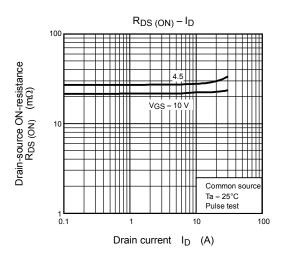




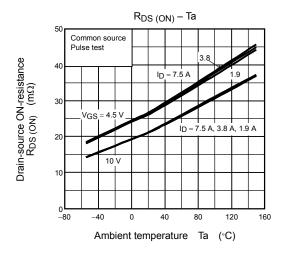


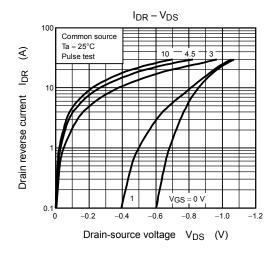


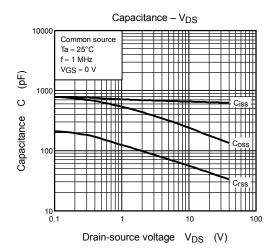


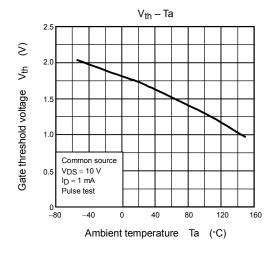


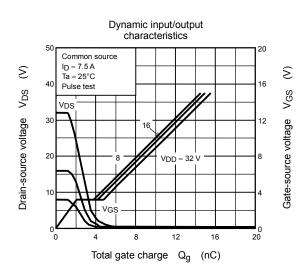
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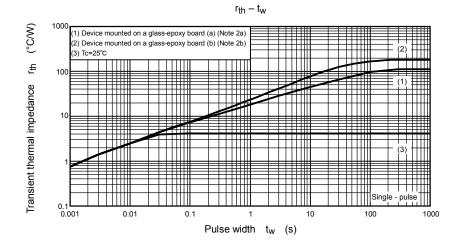


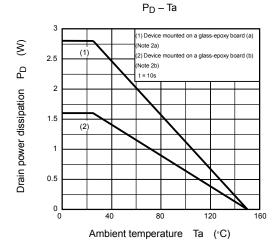


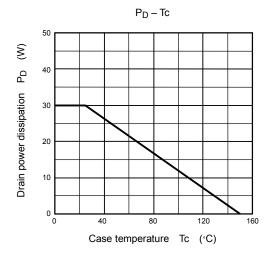


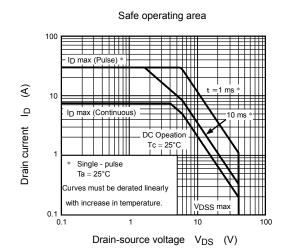


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Handbook" etc. 021023_A

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